

FIGURE 1 (PRIOR ART)

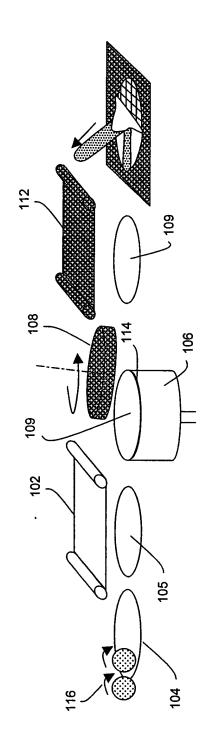


FIGURE 2 (PRIOR ART)

Attorney's Docket No.: 111079-136357 Page 2 of 4
First Named Inventor: Yew Wee Cheong Application No.: Not Yet Assigned
Title: WAFER GRINDING USING AN ADHESIVE GEL MATERIAL
Express Mail Label No. ER084884175US Date of Deposit: 3/31/2004

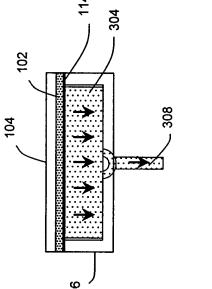


FIGURE 3 (PRIOR ART)

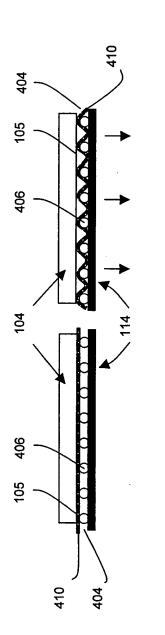
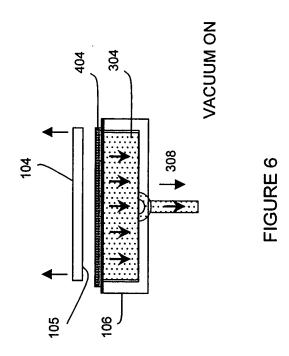
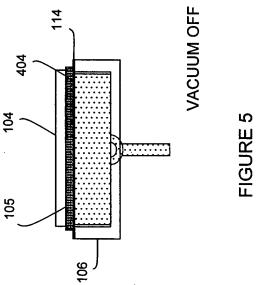


FIGURE 4B





Attorney's Docket No.: 111079-136357 Page 4 of 4
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